

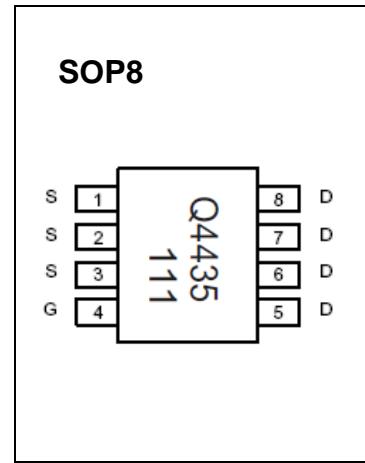
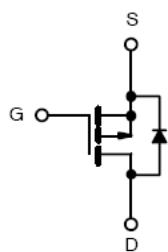


SOP8 Plastic-Encapsulate MOSFETS

CJQ4435 P-Channel MOSFET

APPLICATIONS

- Load Switches
- Battery Switch



Maximum ratings ($T_a=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Units
Drain-Source Voltage	V_{DS}	-30	V
Gate-Source Voltage	V_{GS}	± 20	
Continuous Drain Current ($t = 10\text{s}$) (note 1)	I_D	-9.1	A
Pulsed Drain Current	I_{DM}	-50	
Drain-Source Diode Forward Current ($t = 10\text{s}$) (note 1)	I_S	-2	W
Power Dissipation ($t = 10\text{s}$)	P_D	1.4	
Thermal Resistance from Junction to Ambient ($t \leq 10\text{s}$) (note 1)	$R_{\theta JA}$	89	$^\circ\text{C/W}$
Junction Temperature	T_J	150	$^\circ\text{C}$
Storage Temperature	T_{stg}	-55 ~ +150	

Electrical characteristics ($T_a=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Static Characteristics						
Drain Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}}=0\text{V}, I_D=-250\mu\text{A}$	-30			V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{\text{DS}}=-30\text{V}, V_{\text{GS}}=0\text{V}$			-1	μA
Gate body Leakage	I_{GSS}	$V_{\text{DS}}=0\text{V}, V_{\text{GS}}=\pm 20\text{V}$			± 100	nA
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}}=V_{\text{GS}}, I_D=-250\mu\text{A}$	-1		-3	V
Drain-Source on-state Resistance (note 2)	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}}=-10\text{V}, I_D=-9.1\text{A}$			24	$\text{m}\Omega$
		$V_{\text{GS}}=-4.5\text{V}, I_D=-6.9\text{A}$			35	
Forward Transconductance (note 2)	g_{F}	$V_{\text{DS}}=-10\text{V}, I_D=-9.1\text{A}$	20			S
Dynamic Characteristics (note 3)						
Input Capacitance	C_{iss}	$V_{\text{DS}}=-15\text{V}, V_{\text{GS}}=0\text{V}, f=1\text{MHz}$		1350		pF
Output Capacitance	C_{oss}			215		
Reverse Transfer Capacitance	C_{rss}			185		
Total Gate Charge	Q_g	$V_{\text{DS}}=-15\text{V}, V_{\text{GS}}=-10\text{V}, I_D=-9.1\text{A}$			50	nC
		$V_{\text{DS}}=-15\text{V}, V_{\text{GS}}=-4.5\text{V}, I_D=-9.1\text{A}$			25	
Gate-Source Charge	Q_{gs}			4		
Gate-Drain Charge	Q_{gd}			7.5		
Gate Resistance	R_g	$f=1\text{MHz}$		5.8		Ω
Turn-On Delay Time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}}=-15\text{V}, R_L=15\Omega$ $I_D=-1\text{A}, V_{\text{GEN}}=-10\text{V}, R_G=1\Omega$			15	ns
Rise Time	t_r				15	
Turn-Off Delay Time	$t_{\text{d}(\text{off})}$				70	
Fall Time	t_f				25	
Drain-Source Body Diode Characteristics						
Diode Forward Voltage	V_{SD}	$I_s=-2\text{A}, V_{\text{GS}}=0\text{V}$			-1.2	V

Notes:

1. Surface mounted on 1"×1" FR4 board.
2. Pulse Test : Pulse Width≤300μs, Duty Cycle ≤2%.
3. Guaranteed by design, not subject to production testing.

Typical Characteristics

CJQ4435

